

PCA9552

16-bit I²C-bus LED driver with programmable blink rates

Rev. 05 — 9 March 2006

Product data sheet



1. General description

The PCA9552 LED blinker blinks LEDs in I²C-bus and SMBus applications where it is necessary to limit bus traffic or free up the I²C-bus master's (MCU, MPU, DSP, chip set, etc.) timer. The uniqueness of this device is the internal oscillator with two programmable blink rates. To blink LEDs using normal I/O expanders like the PCF8574 or PCA9554, the bus master must send repeated commands to turn the LED on and off. This greatly increases the amount of traffic on the I²C-bus and uses up one of the master's timers. The PCA9552 LED blinker instead requires only the initial setup command to program BLINK RATE 1 and BLINK RATE 2 (that is, the frequency and duty cycle) for each individual output. From then on, only one command from the bus master is required to turn each individual open-drain output on, off, or to cycle at BLINK RATE 1 or BLINK RATE 2. Maximum output sink current is 25 mA per bit and 200 mA per package.

Any bits not used for controlling the LEDs can be used for General Purpose Parallel Input/Output (GPIO) expansion.

The active LOW hardware reset pin (RESET) and Power-On Reset (POR) initializes the registers to their default state, all zeroes, causing the bits to be set HIGH (LED off).

Three hardware address pins on the PCA9552 allow eight devices to operate on the same bus.

2. Features

- 16 LED drivers (on, off, flashing at a programmable rate)
- 2 selectable, fully programmable blink rates (frequency and duty cycle) between
 0.172 Hz and 44 Hz (5.82 seconds and 0.023 seconds)
- Input/outputs not used as LED drivers can be used as regular GPIOs
- Internal oscillator requires no external components
- I²C-bus interface logic compatible with SMBus
- Internal power-on reset
- Noise filter on SCL/SDA inputs
- Active LOW reset input
- 16 open-drain outputs directly drive LEDs to 25 mA
- Edge rate control on outputs
- No glitch on power-up
- Supports hot insertion
- Low standby current
- Operating power supply voltage range of 2.3 V to 5.5 V
- 0 Hz to 400 kHz clock frequency



- - ESD protection exceeds 2000 V HBM per JESD22-A114, 150 V MM per

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- Latch-up testing is done to JEDEC Standard JESD78 which exceeds 100 mA
- Packages offered: SO24, TSSOP24, HVQFN24

JESD22-A115 and 1000 V CDM per JESD22-C101

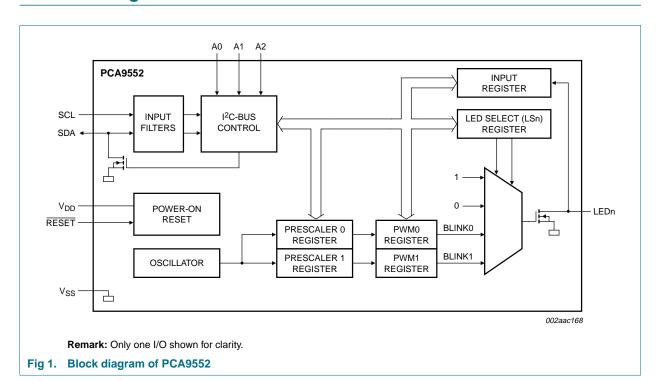
3. Ordering information

Table 1: Ordering information

 $T_{amb} = -40 \,^{\circ}C$ to $+85 \,^{\circ}C$

Type number	Topside mark	Package						
		Name	Description	Version				
PCA9552D	PCA9552D	SO24	plastic small outline package; 24 leads; body width 7.5 mm	SOT137-1				
PCA9552PW	PCA9552	TSSOP24	plastic thin shrink small outline package; 24 leads; body width 4.4 mm	SOT355-1				
PCA9552BS	9552	HVQFN24	plastic thermal enhanced very thin quad flat package; no leads; 24 terminals; body $4\times4\times0.85$ mm	SOT616-1				

4. Block diagram



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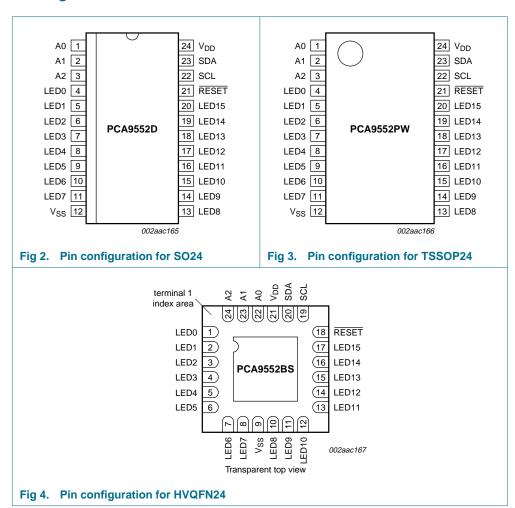
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5. Pinning information

5.1 Pinning



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5.2 Pin description

Table 2: Pin description

Symbol	Pin		Description
	SO24, TSSOP24	HVQFN24	
A0	1	22	address input 0
A1	2	23	address input 1
A2	3	24	address input 2
LED0	4	1	LED driver 0
LED1	5	2	LED driver 1
LED2	6	3	LED driver 2
LED3	7	4	LED driver 3
LED4	8	5	LED driver 4
LED5	9	6	LED driver 5
LED6	10	7	LED driver 6
LED7	11	8	LED driver 7
V _{SS}	12	9 [1]	ground supply
LED8	13	10	LED driver 8
LED9	14	11	LED driver 9
LED10	15	12	LED driver 10
LED11	16	13	LED driver 11
LED12	17	14	LED driver 12
LED13	18	15	LED driver 13
LED14	19	16	LED driver 14
LED15	20	17	LED driver 15
RESET	21	18	active LOW reset input
SCL	22	19	serial clock line
SDA	23	20	serial data line
V_{DD}	24	21	supply voltage

^[1] HVQFN package die supply ground is connected to both V_{SS} pin and exposed center pad. V_{SS} pin must be connected to supply ground for proper device operation. For enhanced thermal, electrical, and board level performance, the exposed pad needs to be soldered to the board using a corresponding thermal pad on the board and for proper heat conduction through the board, thermal vias need to be incorporated in the printed-circuit board in the thermal pad region.

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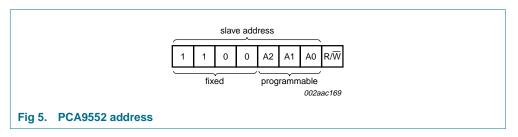
6. Functional description

Refer to Figure 1 "Block diagram of PCA9552".

6.1 Device address

Following a START condition, the bus master must output the address of the slave it is accessing. The address of the PCA9552 is shown in Figure 5. To conserve power, no internal pull-up resistors are incorporated on the hardware selectable address pins and they must be pulled HIGH or LOW.

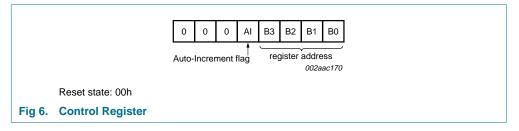
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The last bit of the address byte defines the operation to be performed. When set to logic 1 a read is selected, while a logic 0 selects a write operation.

6.2 Control Register

Following the successful acknowledgement of the slave address, the bus master will send a byte to the PCA9552, which will be stored in the Control Register. This register can be read and written via the I²C-bus.



The lowest 3 bits are used as a pointer to determine which register will be accessed.

If the Auto-Increment flag (AI) is set, the four low order bits of the Control Register are automatically incremented after a read or write. This allows the user to program the registers sequentially. The contents of these bits will rollover to '0000' after the last register is accessed.

When the Auto-Increment flag is set (AI = 1) and a read sequence is initiated, the sequence must start by reading a register different from '0' (B3 B2 B1 B0 \neq 0000).

Only the 4 least significant bits are affected by the AI flag. Unused bits must be programmed with zeroes.

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6.2.1 Control Register definition

Table 3: Register summary

В3	B2	B1	B0	Symbol	Access	Description
0	0	0	0	INPUT0	read only	input register 0
0	0	0	1	INPUT1	read only	input register 1
0	0	1	0	PSC0	read/write	frequency prescaler 0
0	0	1	1	PWM0	read/write	PWM register 0
0	1	0	0	PSC1	read/write	frequency prescaler 1
0	1	0	1	PWM1	read/write	PWM register 1
0	1	1	0	LS0	read/write	LED0 to LED3 selector
0	1	1	1	LS1	read/write	LED4 to LED7 selector
1	0	0	0	LS2	read/write	LED8 to LED11 selector
1	0	0	1	LS3	read/write	LED12 to LED15 selector

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6.3 Register descriptions

6.3.1 INPUT0 - Input register 0

The Input register 0 reflects the state of the device pins (inputs LED0 to LED7). Writes to this register will be acknowledged but will have no effect.

Table 4: INPUT0 - input register 0 description

Bit	7	6	5	4	3	2	1	0
Symbol	LED7	LED6	LED5	LED4	LED3	LED2	LED1	LED0
Default	Х	Х	X	Х	Х	Х	Х	X

Remark: The default value 'X' is determined by the externally applied logic level (normally logic 1) when used for directly driving LED with pull-up to V_{DD}.

6.3.2 INPUT1 - Input register 1

The Input register 1 reflects the state of the device pins (inputs LED8 to LED15). Writes to this register will be acknowledged but will have no effect.

Table 5: INPUT1 - input register 1 description

Bit	7	6	5	4	3	2	1	0
Symbol	LED15	LED14	LED13	LED12	LED11	LED10	LED9	LED8
Default	Х	Х	Х	Х	Х	Х	Х	X

Remark: The default value 'X' is determined by the externally applied logic level (normally logic 1) when used for directly driving LED with pull-up to V_{DD} .

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6.3.3 PCS0 - Frequency Prescaler 0

PSC0 is used to program the period of the PWM output.

The period of BLINK0 = (PSC0 + 1) / 44.

Table 6: PSC0 - Frequency Prescaler 0 register description

Bit	7	6	5	4	3	2	1	0
Symbol	PSC0[7]	PSC0[6]	PSC0[5]	PSC0[4]	PSC0[3]	PSC0[2]	PSC0[1]	PSC0[0]
Default	1	1	1	1	1	1	1	1

6.3.4 PWM0 - Pulse Width Modulation 0

The PWM0 register determines the duty cycle of BLINK0. The outputs are LOW (LED off) when the count is less than the value in PWM0 and HIGH when it is greater. If PWM0 is programmed with 00h, then the PWM0 output is always LOW.

The duty cycle of BLINK0 = (256 - PWM0) / 256.

Table 7: PWM0 - Pulse Width Modulation 0 register description

Bit	7	6	5	4	3	2	1	0
Symbol	PWM0 [7]	PWM0 [6]	PWM0 [5]	PWM0 [4]	PWM0 [3]	PWM0 [2]	PWM0 [1]	PWM0 [0]
Default	1	0	0	0	0	0	0	0

6.3.5 PCS1 - Frequency Prescaler 1

PSC1 is used to program the period of the PWM output.

The period of BLINK1 = (PSC1 + 1) / 44.

Table 8: PSC1 - Frequency Prescaler 1 register description

Bit	7	6	5	4	3	2	1	0
Symbol	PSC1[7]	PSC1[6]	PSC1[5]	PSC1[4]	PSC1[3]	PSC1[2]	PSC1[1]	PSC1[0]
Default	1	1	1	1	1	1	1	1

6.3.6 PWM1 - Pulse Width Modulation 1

The PWM1 register determines the duty cycle of BLINK1. The outputs are LOW (LED off) when the count is less than the value in PWM1 and HIGH when it is greater. If PWM1 is programmed with 00h, then the PWM1 output is always LOW.

The duty cycle of BLINK1 = (256 - PWM1) / 256.

Table 9: PWM1 - Pulse Width Modulation 1 register description

Bit	7	6	5	4	3	2	1	0
Symbol	PWM1 [7]	PWM1 [6]	PWM1 [5]	PWM1 [4]	PWM1 [3]	PWM1 [2]	PWM1 [1]	PWM1 [0]
Default	1	0	0	0	0	0	0	0

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6.3.7 LS0 to LS3 - LED selector registers

The LSn LED select registers determine the source of the LED data.

00 = output is set LOW (LED on)

01 = output is set high-impedance (LED off; default)

10 = output blinks at PWM0 rate

11 = output blinks at PWM1 rate

Table 10: LS0 to LS3 - LED selector registers bit description

Legend: * default value

Register	Bit	Value	Description
LS0 - LED0	to LED3	selector	
LS0	7:6	01*	LED3 selected
	5:4	01*	LED2 selected
	3:2	01*	LED1 selected
	1:0	01*	LED0 selected
LS1 - LED4	to LED7	selector	
LS1	7:6	01*	LED7 selected
	5:4	01*	LED6 selected
	3:2	01*	LED5 selected
	1:0	01*	LED4 selected
LS2 - LED8	to LED1	1 selector	
LS2	7:6	01*	LED11 selected
	5:4	01*	LED10 selected
	3:2	01*	LED9 selected
	1:0	01*	LED8 selected
LS3 - LED1	2 to LED	15 selector	
LS3	7:6	01*	LED15 selected
	5:4	01*	LED14 selected
	3:2	01*	LED13 selected
	1:0	01*	LED12 selected

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6.4 Pins used as GPIOs

LED pins not used to control LEDs can be used as general purpose I/Os (GPIOs).

For use as input, set LEDn to high-impedance (01) and then read the pin state via the input register.

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For use as output, connect external pull-up resistor to the pin and size it according to the DC recommended operating characteristics. LED output pin is HIGH when the output is programmed as high-impedance, and LOW when the output is programmed LOW through the 'LED selector' register. The output can be pulse-width controlled when PWM0 or PWM1 are used.

6.5 Power-on reset

When power is applied to V_{DD} , an internal Power-On Reset (POR) holds the PCA9552 in a reset condition until V_{DD} has reached V_{POR} . At that point, the reset condition is released and the PCA9552 registers are initialized to their default states. Thereafter, V_{DD} must be lowered below 0.2 V to reset the device.

6.6 External RESET

A reset can be accomplished by holding the $\overline{\text{RESET}}$ pin LOW for a minimum of $t_{\text{w(rst)}}$. The PCA9552 registers and I²C-bus state machine will be held in their default states until the $\overline{\text{RESET}}$ input is once again HIGH.

This input requires a pull-up resistor to V_{DD} if no active connection is used.



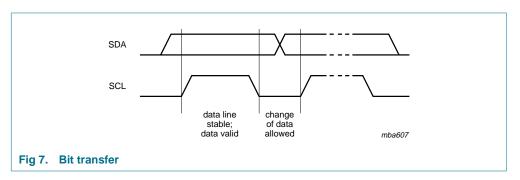
7. Characteristics of the I²C-bus

The I²C-bus is for 2-way, 2-line communication between different ICs or modules. The two lines are a serial data line (SDA) and a serial clock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor when connected to the output stages of a device. Data transfer may be initiated only when the bus is not busy.

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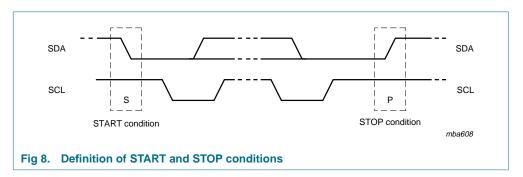
7.1 Bit transfer

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse as changes in the data line at this time will be interpreted as control signals (see Figure 7).



7.1.1 START and STOP conditions

Both data and clock lines remain HIGH when the bus is not busy. A HIGH-to-LOW transition of the data line while the clock is HIGH is defined as the START condition (S). A LOW-to-HIGH transition of the data line while the clock is HIGH is defined as the STOP condition (P) (see Figure 8.)



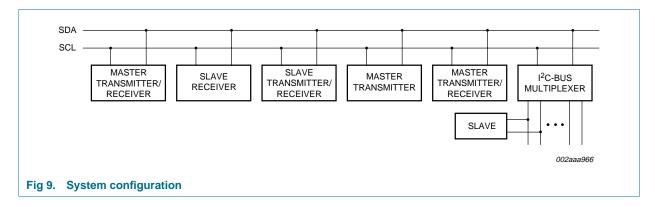
7.2 System configuration

A device generating a message is a 'transmitter'; a device receiving is the 'receiver'. The device that controls the message is the 'master' and the devices which are controlled by the master are the 'slaves' (see Figure 9).

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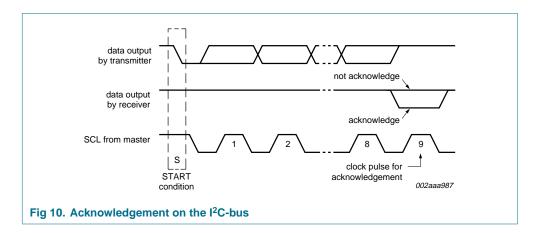


7.3 Acknowledge

The number of data bytes transferred between the START and the STOP conditions from transmitter to receiver is not limited. Each byte of eight bits is followed by one acknowledge bit. The acknowledge bit is a HIGH level put on the bus by the transmitter, whereas the master generates an extra acknowledge related clock pulse.

A slave receiver which is addressed must generate an acknowledge after the reception of each byte. Also a master must generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter. The device that acknowledges has to pull down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse; set-up and hold times must be taken into account.

A master receiver must signal an end of data to the transmitter by not generating an acknowledge on the last byte that has been clocked out of the slave. In this event, the transmitter must leave the data line HIGH to enable the master to generate a STOP condition.

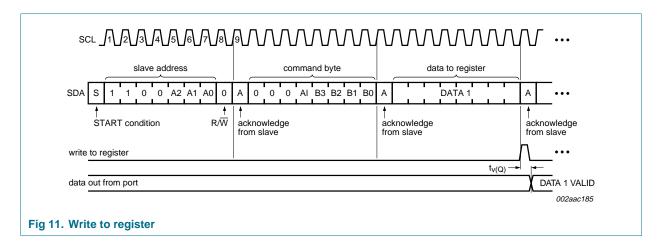


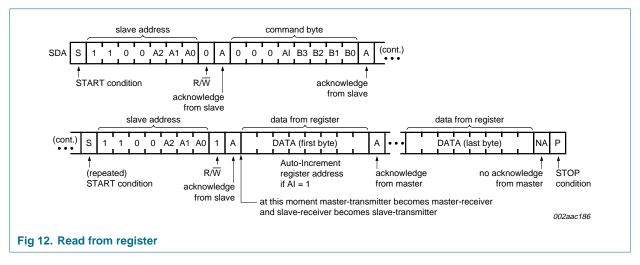
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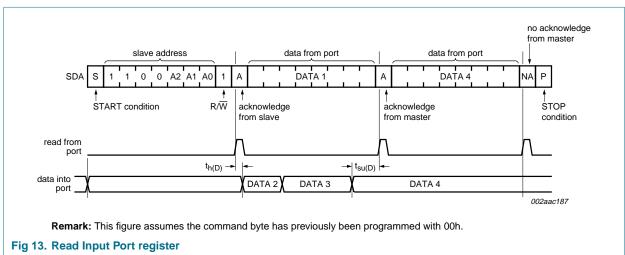


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7.4 Bus transactions





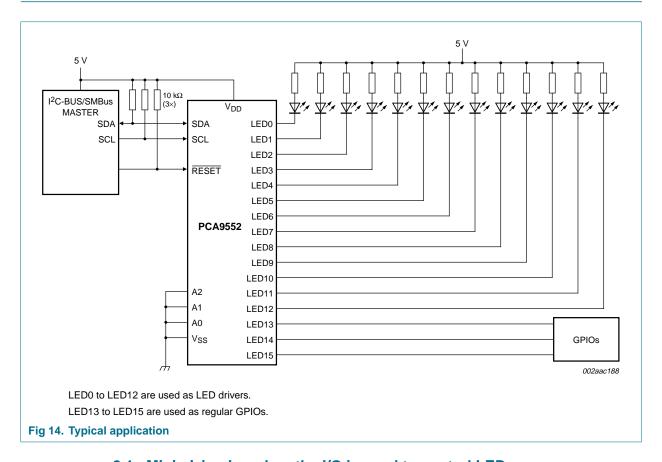


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8. Application design-in information



8.1 Minimizing I_{DD} when the I/O is used to control LEDs

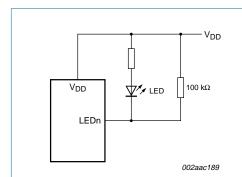
When the I/Os are used to control LEDs, they are normally connected to V_{DD} through a resistor as shown in Figure 15. Since the LED acts as a diode, when the LED is off the I/O V_{I} is about 1.2 V less than V_{DD} . The supply current, I_{DD} , increases as V_{I} becomes lower than V_{DD} and is specified as ΔI_{stb} in Table 13 "Static characteristics".

Designs needing to minimize current consumption, such as battery power applications, should consider maintaining the I/O pins greater than or equal to V_{DD} when the LED is off. Figure 15 shows a high value resistor in parallel with the LED. Figure 16 shows V_{DD} less than the LED supply voltage by at least 1.2 V. Both of these methods maintain the input/output V_{I} at or above V_{DD} and prevents additional supply current consumption when the LED is off.

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3.3 V 5 V V_{DD} **▼**″ LED LEDn 002aac190

Fig 15. High value resistor in parallel with the LED

Fig 16. Device supplied by a lower voltage

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8.2 Programming example

The following example will show how to set LED0 to LED3 on. It will then set LED4 and LED5 to blink at 1 Hz at a 50 % duty cycle. LED6 and LED7 will be set to blink at 4 Hz and at a 25 % duty cycle. LED8 to LED15 will be set to off.

Table 11: Programming PCA9552

Blink period = $I = \frac{PSC0 + I}{44}$ PSC0 = 43 Set PWM0 duty cycle to 50 %: 80h $\frac{256 - PWM0}{256} = 0.5$ PWM0 = 128 Set prescaler PCS1 to achieve a period of 0.25 seconds: 0Ah Blink period = $0.25 = \frac{PSC1 + I}{44}$ PSC1 = 10 Set PWM1 output duty cycle to 25 %: C0h $\frac{256 - PWM1}{256} = 0.25$ PWM1 = 192 Set LED0 to LED3 on 00h Set LED4 and LED5 to PWM0, and LED6 or LED7 to PWM1 FAh	Table 11: Programming PCA9552	
PCA9552 address with A0 to A2 = LOW PSC0 subaddress + Auto-Increment Set prescaler PSC0 to achieve a period of 1 second: Blink period = $I = \frac{PSC0 + I}{44}$ PSC0 = 43 Set PWM0 duty cycle to 50 %: 80h $\frac{256 - PWM0}{256} = 0.5$ PWM0 = 128 Set prescaler PCS1 to achieve a period of 0.25 seconds: OAh Blink period = $0.25 = \frac{PSC1 + I}{44}$ PSC1 = 10 Set PWM1 output duty cycle to 25 %: C0h $\frac{256 - PWM1}{256} = 0.25$ PWM1 = 192 Set LED0 to LED3 on O0h Set LED4 and LED5 to PWM0, and LED6 or LED7 to PWM1 FAh Set LED8 to LED11 off 55h Set LED12 to LED15 off	Program sequence	I ² C-bus
PSC0 subaddress + Auto-Increment 12h Set prescaler PSC0 to achieve a period of 1 second: 2Bh Blink period = $I = \frac{PSC0 + I}{44}$ PSC0 = 43 Set PWM0 duty cycle to 50 %: 80h $\frac{256 - PWM0}{256} = 0.5$ PWM0 = 128 Set prescaler PCS1 to achieve a period of 0.25 seconds: 0Ah Blink period = $0.25 = \frac{PSC1 + I}{44}$ PSC1 = 10 Set PWM1 output duty cycle to 25 %: C0h $\frac{256 - PWM1}{256} = 0.25$ PWM1 = 192 Set LED0 to LED3 on 00h Set LED4 and LED5 to PWM0, and LED6 or LED7 to PWM1 FAh Set LED8 to LED11 off 55h Set LED12 to LED15 off 55h	START	S
Set prescaler PSC0 to achieve a period of 1 second: $Blink \ period = I = \frac{PSC0 + I}{44}$ $PSC0 = 43$ Set PWM0 duty cycle to 50 %: $\frac{256 - PWM0}{256} = 0.5$ $PWM0 = 128$ Set prescaler PCS1 to achieve a period of 0.25 seconds: $0Ah$ $Blink \ period = 0.25 = \frac{PSC1 + I}{44}$ $PSC1 = 10$ Set PWM1 output duty cycle to 25 %: $\frac{256 - PWM1}{256} = 0.25$ $PWM1 = 192$ Set LED0 to LED3 on $00h$ Set LED4 and LED5 to PWM0, and LED6 or LED7 to PWM1 FAh Set LED8 to LED11 off $55h$ Set LED12 to LED15 off	PCA9552 address with A0 to A2 = LOW	C0h
Blink period = $I = \frac{\text{PSC0} + I}{44}$ PSC0 = 43 Set PWM0 duty cycle to 50 %: 80h $\frac{256 - \text{PWM0}}{256} = 0.5$ PWM0 = 128 Set prescaler PCS1 to achieve a period of 0.25 seconds: 0Ah Blink period = $0.25 = \frac{\text{PSC1} + I}{44}$ PSC1 = 10 Set PWM1 output duty cycle to 25 %: C0h $\frac{256 - \text{PWM1}}{256} = 0.25$ PWM1 = 192 Set LED0 to LED3 on 00h Set LED4 and LED5 to PWM0, and LED6 or LED7 to PWM1 FAh Set LED8 to LED11 off 55h Set LED12 to LED15 off 55h	PSC0 subaddress + Auto-Increment	12h
PSC0 = 43 Set PWM0 duty cycle to 50 %: 80h $\frac{256 - \text{PWM0}}{256} = 0.5$ PWM0 = 128 Set prescaler PCS1 to achieve a period of 0.25 seconds: 0Ah Blink period = $0.25 = \frac{\text{PSC1} + l}{44}$ PSC1 = 10 Set PWM1 output duty cycle to 25 %: C0h $\frac{256 - \text{PWM1}}{256} = 0.25$ PWM1 = 192 Set LED0 to LED3 on 00h Set LED4 and LED5 to PWM0, and LED6 or LED7 to PWM1 FAh Set LED8 to LED11 off 55h Set LED12 to LED15 off 55h	Set prescaler PSC0 to achieve a period of 1 second:	2Bh
Set PWM0 duty cycle to 50 %: $\frac{256 - \text{PWM0}}{256} = 0.5$ PWM0 = 128 Set prescaler PCS1 to achieve a period of 0.25 seconds: OAh $\text{Blink period} = 0.25 = \frac{\text{PSC1} + l}{44}$ $\text{PSC1} = 10$ Set PWM1 output duty cycle to 25 %: $\frac{256 - \text{PWM1}}{256} = 0.25$ $\text{PWM1} = 192$ Set LED0 to LED3 on $\text{Sot LED4 and LED5 to PWM0, and LED6 or LED7 to PWM1}$ $\text{Sot LED4 to LED11 off}$ $\text{Sot LED12 to LED15 off}$	Blink period = $I = \frac{PSC0 + I}{44}$	
$\frac{256 - \text{PWM0}}{256} = 0.5$ $\text{PWM0} = 128$ Set prescaler PCS1 to achieve a period of 0.25 seconds: OAh Blink period = $0.25 = \frac{\text{PSC1} + l}{44}$ $\text{PSC1} = 10$ Set PWM1 output duty cycle to 25 %: C0h $\frac{256 - \text{PWM1}}{256} = 0.25$ $\text{PWM1} = 192$ Set LED0 to LED3 on O0h Set LED4 and LED5 to PWM0, and LED6 or LED7 to PWM1 FAh Set LED8 to LED11 off 55h	PSC0 = 43	
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Set prescaler PCS1 to achieve a period of 0.25 seconds: $Blink \ period = 0.25 = \frac{PSC1 + I}{44}$ $PSC1 = 10$ Set PWM1 output duty cycle to 25 %: $C0h$ $\frac{256 - PWM1}{256} = 0.25$ $PWM1 = 192$ Set LED0 to LED3 on $Set \ LED4 \ and \ LED5 \ to \ PWM0, \ and \ LED6 \ or \ LED7 \ to \ PWM1$ FAh Set LED8 to LED11 off $55h$ Set LED12 to LED15 off	$\frac{256 - \text{PWM0}}{256} = 0.5$	
Blink period = $0.25 = \frac{\text{PSC1} + I}{44}$ PSC1 = 10 Set PWM1 output duty cycle to 25 %: $\frac{256 - \text{PWM1}}{256} = 0.25$ PWM1 = 192 Set LED0 to LED3 on 00h Set LED4 and LED5 to PWM0, and LED6 or LED7 to PWM1 FAh Set LED8 to LED11 off 55h	PWM0 = 128	
PSC1 = 10 Set PWM1 output duty cycle to 25 %: C0h $\frac{256 - \text{PWM1}}{256} = 0.25$ PWM1 = 192 Set LED0 to LED3 on 00h Set LED4 and LED5 to PWM0, and LED6 or LED7 to PWM1 FAh Set LED8 to LED11 off 55h	Set prescaler PCS1 to achieve a period of 0.25 seconds:	0Ah
Set PWM1 output duty cycle to 25 %: C0h $\frac{256 - \text{PWM1}}{256} = 0.25$ $\text{PWM1} = 192$ Set LED0 to LED3 on 00h Set LED4 and LED5 to PWM0, and LED6 or LED7 to PWM1 FAh Set LED8 to LED11 off 55h Set LED12 to LED15 off 55h	Blink period = $0.25 = \frac{PSC1 + I}{44}$	
$\frac{256 - \text{PWM1}}{256} = 0.25$ $\text{PWM1} = 192$ $\text{Set LED0 to LED3 on} \qquad \qquad 00\text{h}$ $\text{Set LED4 and LED5 to PWM0, and LED6 or LED7 to PWM1} \qquad \text{FAh}$ $\text{Set LED8 to LED11 off} \qquad \qquad 55\text{h}$ $\text{Set LED12 to LED15 off} \qquad \qquad 55\text{h}$	PSC1 = 10	
PWM1 = 192 Set LED0 to LED3 on 00h Set LED4 and LED5 to PWM0, and LED6 or LED7 to PWM1 FAh Set LED8 to LED11 off 55h Set LED12 to LED15 off 55h	Set PWM1 output duty cycle to 25 %:	C0h
Set LED0 to LED3 on 00h Set LED4 and LED5 to PWM0, and LED6 or LED7 to PWM1 FAh Set LED8 to LED11 off 55h Set LED12 to LED15 off 55h	$\frac{256 - \text{PWM1}}{256} = 0.25$	
Set LED4 and LED5 to PWM0, and LED6 or LED7 to PWM1 FAh Set LED8 to LED11 off 55h Set LED12 to LED15 off 55h	PWM1 = 192	
Set LED8 to LED11 off 55h Set LED12 to LED15 off 55h	Set LED0 to LED3 on	00h
Set LED12 to LED15 off 55h	Set LED4 and LED5 to PWM0, and LED6 or LED7 to PWM1	FAh
	Set LED8 to LED11 off	55h
STOP P	Set LED12 to LED15 off	55h
	STOP	Р

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9. Limiting values

Table 12: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DD}	supply voltage		-0.5	+6.0	V
$V_{I/O}$	voltage on an input/output pin	LEDn used as an I/O	$V_{SS}-0.5$	5.5	V
$I_{O(LEDn)}$	output current on pin LEDn	LEDn used as an I/O	-	±25	mA
I _{SS}	ground supply current		-	200	mA
P_{tot}	total power dissipation		-	400	mW
T _{stg}	storage temperature		-65	+150	°C
T_{amb}	ambient temperature	operating	-40	+85	°C

10. Static characteristics

Table 13: Static characteristics

 V_{DD} = 2.3 V to 5.5 V; V_{SS} = 0 V; T_{amb} = -40 °C to +85 °C; unless otherwise specified.

Symbol	Parameter	Conditions	N	lin	Typ [1]	Max	Unit
Supply							
V_{DD}	supply voltage		2	.3	-	5.5	V
I _{DD}	supply current	Operating mode; V_{DD} = 5.5 V; no load; V_{I} = V_{DD} or V_{SS} ; f_{SCL} = 100 kHz	-		350	550	μΑ
I _{stb}	standby current	Standby mode; $V_{DD} = 5.5 \text{ V}$; no load; $V_{I} = V_{DD}$ or V_{SS} ; $f_{SCL} = 0 \text{ kHz}$	-		2.1	5.0	μΑ
ΔI_{stb}	additional standby current	Standby mode; $V_{DD} = 5.5 \text{ V}$; every LED I/O at $V_{I} = 4.3 \text{ V}$; $f_{SCL} = 0 \text{ kHz}$	-		-	2	mA
V_{POR}	power-on reset voltage [2]	V_{DD} = 3.3 V; no load; V_{I} = V_{DD} or V_{SS}	-		1.7	2.2	V
Input SCI	_; input/output SDA						
V _{IL}	LOW-level input voltage		_	0.5	-	$0.3V_{DD}$	V
V _{IH}	HIGH-level input voltage		0	.7V _{DD}	-	5.5	V
I _{OL}	LOW-level output current	V _{OL} = 0.4 V	3		6.5	-	mΑ
IL	leakage current	$V_{I} = V_{DD} = V_{SS}$	_	1	-	+1	μΑ
Ci	input capacitance	$V_I = V_{SS}$	-		4.4	5	pF
I/Os							
V _{IL}	LOW-level input voltage		_	0.5	-	0.8	V
V _{IH}	HIGH-level input voltage		2	.0	-	5.5	V
I _{OL}	LOW-level output current	$V_{OL} = 0.4 \text{ V}; V_{DD} = 2.3 \text{ V}$	<u>[3]</u> 9		-	-	mA
		$V_{OL} = 0.4 \text{ V}; V_{DD} = 3.0 \text{ V}$	<u>[3]</u> 1	2	-	-	mΑ
		$V_{OL} = 0.4 \text{ V}; V_{DD} = 5.0 \text{ V}$	<u>[3]</u> 1	5	-	-	mΑ
		$V_{OL} = 0.7 \text{ V}; V_{DD} = 2.3 \text{ V}$	[<u>3]</u> 1	5	-	-	mA
		$V_{OL} = 0.7 \text{ V}; V_{DD} = 3.0 \text{ V}$	[3] 2	0	-	-	mA
		$V_{OL} = 0.7 \text{ V}; V_{DD} = 5.0 \text{ V}$	[3] 2	5	-	-	mA
ILI	input leakage current	$V_{DD} = 3.6 \text{ V}; V_I = 0 \text{ V or } V_{DD}$	_	1	-	+1	μΑ
C _{io}	input/output capacitance		-		2.6	5 nics N.V. 2006. All	pF



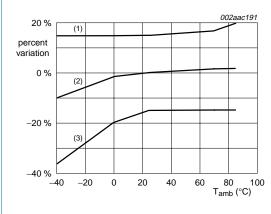
16-bit I²C-bus LED driver with programmable blink rates

Table 13: Static characteristics ... continued

 V_{DD} = 2.3 V to 5.5 V; V_{SS} = 0 V; T_{amb} = -40 °C to +85 °C; unless otherwise specified.

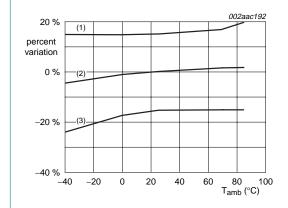
Symbol	Parameter	Conditions	Min	Typ [1]	Max	Unit
Select in	puts A0, A1, A2; RESET					
V _{IL}	LOW-level input voltage		-0.5	-	0.8	V
V_{IH}	HIGH-level input voltage		2.0	-	5.5	V
I _{LI}	input leakage current		-1	-	+1	μΑ
Ci	input capacitance	$V_I = V_{SS}$	-	2.3	5	pF

- [1] All typical values at 3.3 V and 25 $^{\circ}$ C.
- [2] V_{DD} must be lowered to 0.2 V in order to reset part.
- [3] Each I/O must be externally limited to a maximum of 25 mA and each octal ([LED0 to LED7] and [LED8 to LED15]) must be limited to a maximum current of 100 mA for a device total of 200 mA.



- (1) maximum
- (2) average
- (3) minimum

Fig 17. Typical frequency variation over process at $V_{DD} = 2.3 \text{ V to } 3.0 \text{ V}$



- (1) maximum
- (2) average
- (3) minimum

Fig 18. Typical frequency variation over process at $V_{DD} = 3.0 \text{ V to } 5.5 \text{ V}$



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11. Dynamic characteristics

Table 14: Dynamic characteristics

Symbol	Parameter	Conditions			rd mode -bus			Unit	
				Min	Max	Min	Max		
f _{SCL}	SCL clock frequency		·	0	100	0	400	kHz	
t _{BUF}	bus free time between a STOP and START condition			4.7	-	1.3	-	μs	
t _{HD;STA}	hold time (repeated) START condition			4.0	-	0.6	-	μs	
t _{SU;STA}	set-up time for a repeated START condition			4.7	-	0.6	-	μs	
t _{SU;STO}	set-up time for STOP condition			4.0	-	0.6	-	μs	
t _{HD;DAT}	data hold time			0	-	0	-	ns	
t _{VD;ACK}	data valid acknowledge time		<u>[1]</u>	-	600	-	600	ns	
t _{VD;DAT}	data valid time	LOW-level	[2]	-	600	-	600	ns	
		HIGH-level	[2]	-	1500	-	600	ns	
t _{SU;DAT}	data set-up time			250	-	100	-	ns	
t _{LOW}	LOW period of the SCL clock			4.7	-	1.3	-	μs	
t _{HIGH}	HIGH period of the SCL clock			4.0	-	0.6	-	μs	
t _f	fall time of both SDA and SCL signals			-	300	$20 + 0.1C_b$ [3]	300	ns	
t _r	rise time of both SDA and SCL signals			-	1000	20 + 0.1C _b [3]	300	ns	
t _{SP}	pulse width of spikes that must be suppressed by the input filter			-	50	-	50	ns	
Port timir	ng								
t _{v(Q)}	data output valid time			-	250	-	250	ns	
t _{su(D)}	data input setup time			100	-	100	-	ns	
t _{h(D)}	data input hold time			1	-	1	-	μs	
Reset									
t _{w(rst)}	reset pulse width			10	-	10	-	ns	
t _{rec(rst)}	reset recovery time			0	-	0	-	ns	
t _{rst}	reset time		[4] [5]	400	-	400	-	ns	

^[1] $t_{VD;ACK}$ = time for Acknowledgement signal from SCL LOW to SDA (out) LOW.

^[2] $t_{VD;DAT}$ = minimum time for SDA data out to be valid following SCL LOW.

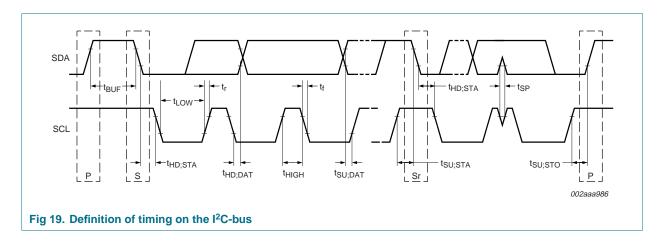
^[3] $C_b = \text{total capacitance of one bus line in pF.}$

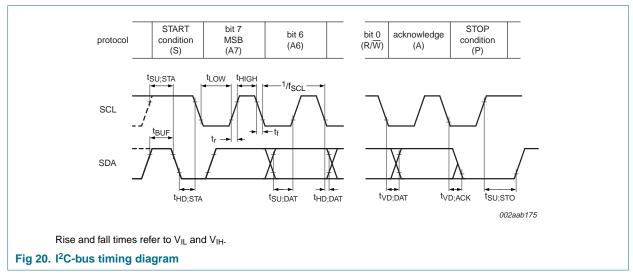
^[4] Resetting the device while actively communicating on the bus may cause glitches or errant STOP conditions.

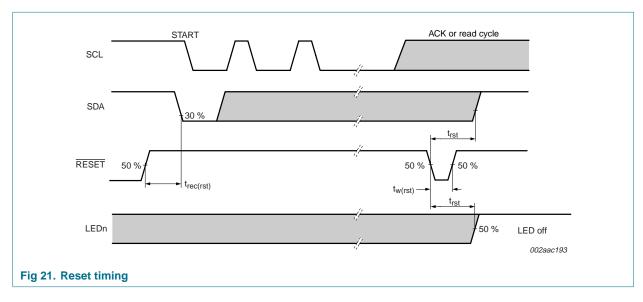
^[5] Upon reset, the full delay will be the sum of t_{rst} and the RC time constant of the SDA bus.



16-bit I²C-bus LED driver with programmable blink rates







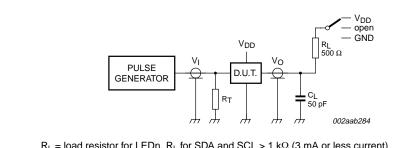
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12. Test information



 R_L = load resistor for LEDn. R_L for SDA and SCL > 1 $k\Omega$ (3 mA or less current)

C_L = load capacitance includes jig and probe capacitance

 R_T = termination resistance should be equal to the output impedance Z_0 of the pulse generators.

Fig 22. Test circuitry for switching times

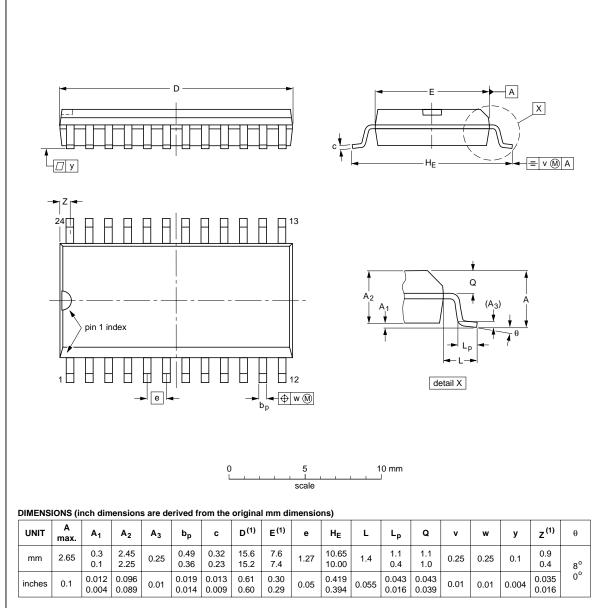
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13. Package outline

SO24: plastic small outline package; 24 leads; body width 7.5 mm

SOT137-1



Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT137-1	075E05	MS-013				99-12-27 03-02-19

Fig 23. Package outline SOT137-1 (SO24)

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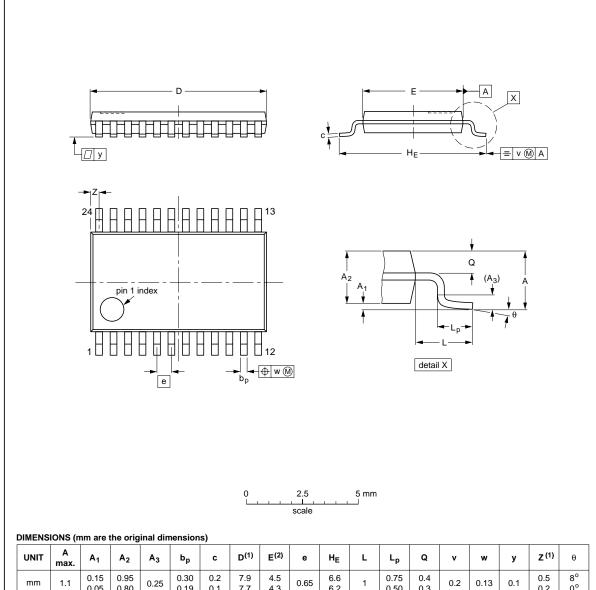
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TSSOP24: plastic thin shrink small outline package; 24 leads; body width 4.4 mm

SOT355-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	7.9 7.7	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT355-1		MO-153			99-12-27 03-02-19

Fig 24. Package outline SOT355-1 (TSSOP24)

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HVQFN24: plastic thermal enhanced very thin quad flat package; no leads; 24 terminals; body $4 \times 4 \times 0.85$ mm

SOT616-1

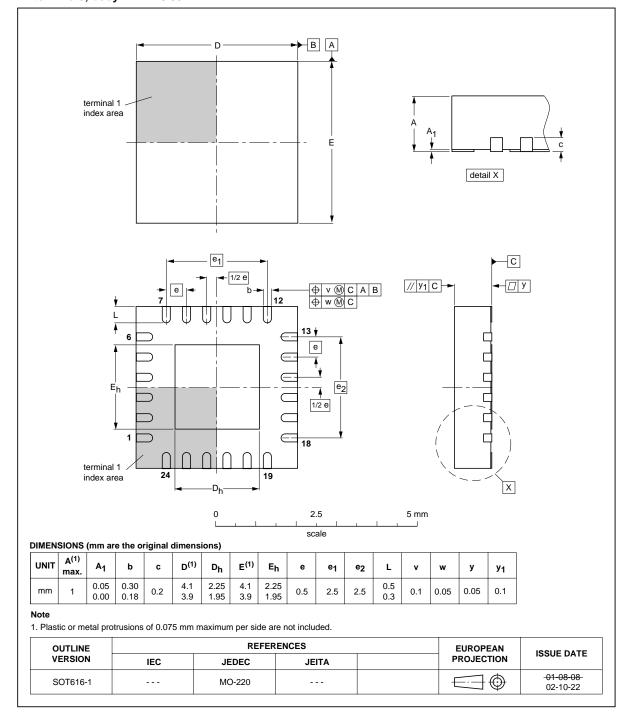


Fig 25. Package outline SOT616-1 (HVQFN24)

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14. Handling information

Inputs and outputs are protected against electrostatic discharge in normal handling. However, to be completely safe you must take normal precautions appropriate to handling integrated circuits.

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15. Soldering

15.1 Introduction to soldering surface mount packages

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our *Data Handbook IC26*; *Integrated Circuit Packages* (document order number 9398 652 90011).

There is no soldering method that is ideal for all surface mount IC packages. Wave soldering can still be used for certain surface mount ICs, but it is not suitable for fine pitch SMDs. In these situations reflow soldering is recommended.

15.2 Reflow soldering

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement. Driven by legislation and environmental forces the worldwide use of lead-free solder pastes is increasing.

Several methods exist for reflowing; for example, convection or convection/infrared heating in a conveyor type oven. Throughput times (preheating, soldering and cooling) vary between 100 seconds and 200 seconds depending on heating method.

Typical reflow peak temperatures range from 215 °C to 270 °C depending on solder paste material. The top-surface temperature of the packages should preferably be kept:

- below 225 °C (SnPb process) or below 245 °C (Pb-free process)
 - for all BGA, HTSSON..T and SSOP..T packages
 - for packages with a thickness ≥ 2.5 mm
 - for packages with a thickness < 2.5 mm and a volume ≥ 350 mm³ so called thick/large packages.
- below 240 °C (SnPb process) or below 260 °C (Pb-free process) for packages with a thickness < 2.5 mm and a volume < 350 mm³ so called small/thin packages.

Moisture sensitivity precautions, as indicated on packing, must be respected at all times.

15.3 Wave soldering

Conventional single wave soldering is not recommended for surface mount devices (SMDs) or printed-circuit boards with a high component density, as solder bridging and non-wetting can present major problems.

To overcome these problems the double-wave soldering method was specifically developed.

If wave soldering is used the following conditions must be observed for optimal results:

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- 16-bit I²C-bus LED driver with programmable blink rates
- Use a double-wave soldering method comprising a turbulent wave with high upward pressure followed by a smooth laminar wave.
- For packages with leads on two sides and a pitch (e):
 - larger than or equal to 1.27 mm, the footprint longitudinal axis is preferred to be parallel to the transport direction of the printed-circuit board;
 - smaller than 1.27 mm, the footprint longitudinal axis must be parallel to the transport direction of the printed-circuit board.

The footprint must incorporate solder thieves at the downstream end.

 For packages with leads on four sides, the footprint must be placed at a 45° angle to the transport direction of the printed-circuit board. The footprint must incorporate solder thieves downstream and at the side corners.

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Typical dwell time of the leads in the wave ranges from 3 seconds to 4 seconds at 250 °C or 265 °C, depending on solder material applied, SnPb or Pb-free respectively.

A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

15.4 Manual soldering

Fix the component by first soldering two diagonally-opposite end leads. Use a low voltage (24 V or less) soldering iron applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300 °C.

When using a dedicated tool, all other leads can be soldered in one operation within 2 seconds to 5 seconds between 270 °C and 320 °C.

15.5 Package related soldering information

Table 15: Suitability of surface mount IC packages for wave and reflow soldering methods

Package [1]	Soldering method			
	Wave	Reflow [2]		
BGA, HTSSONT 3, LBGA, LFBGA, SQFP, SSOPT 3, TFBGA, VFBGA, XSON	not suitable	suitable		
DHVQFN, HBCC, HBGA, HLQFP, HSO, HSOP, HSQFP, HSSON, HTQFP, HTSSOP, HVQFN, HVSON, SMS	not suitable [4]	suitable		
PLCC [5], SO, SOJ	suitable	suitable		
LQFP, QFP, TQFP	not recommended [5] [6]	suitable		
SSOP, TSSOP, VSO, VSSOP	not recommended [7]	suitable		
CWQCCNL[8], PMFP[9], WQCCNL[8]	not suitable	not suitable		

For more detailed information on the BGA packages refer to the (LF)BGA Application Note (AN01026); order a copy from your Philips Semiconductors sales office.

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- 16-bit I²C-bus LED driver with programmable blink rates
- [2] All surface mount (SMD) packages are moisture sensitive. Depending upon the moisture content, the maximum temperature (with respect to time) and body size of the package, there is a risk that internal or external package cracks may occur due to vaporization of the moisture in them (the so called popcorn effect). For details, refer to the Drypack information in the Data Handbook IC26; Integrated Circuit Packages; Section: Packing Methods.
- [3] These transparent plastic packages are extremely sensitive to reflow soldering conditions and must on no account be processed through more than one soldering cycle or subjected to infrared reflow soldering with peak temperature exceeding 217 °C ± 10 °C measured in the atmosphere of the reflow oven. The package body peak temperature must be kept as low as possible.
- [4] These packages are not suitable for wave soldering. On versions with the heatsink on the bottom side, the solder cannot penetrate between the printed-circuit board and the heatsink. On versions with the heatsink on the top side, the solder might be deposited on the heatsink surface.
- [5] If wave soldering is considered, then the package must be placed at a 45° angle to the solder wave direction. The package footprint must incorporate solder thieves downstream and at the side corners.
- [6] Wave soldering is suitable for LQFP, QFP and TQFP packages with a pitch (e) larger than 0.8 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.65 mm.
- [7] Wave soldering is suitable for SSOP, TSSOP, VSO and VSSOP packages with a pitch (e) equal to or larger than 0.65 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.5 mm.
- [8] Image sensor packages in principle should not be soldered. They are mounted in sockets or delivered pre-mounted on flex foil. However, the image sensor package can be mounted by the client on a flex foil by using a hot bar soldering process. The appropriate soldering profile can be provided on request.
- [9] Hot bar soldering or manual soldering is suitable for PMFP packages.

16. Abbreviations

Table 16: Abbreviations

Acronym	Description
CDM	Charged Device Model
DSP	Digital Signal Processor
ESD	ElectroStatic Discharge
НВМ	Human Body Model
GPIO	General Purpose Input/Output
IC	Integrated Circuit
I ² C-bus	Inter IC bus
LED	Light Emitting Diode
MCU	Microcontroller
MM	Machine Model
MPU	Microprocessor
POR	Power-On Reset
PWM	Pulse Width Modulation
SMBus	System Management Bus

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17. Revision history

Table 17: Revision history

Document ID	Release date	Data sheet status	Change notice	Doc. number	Supersedes			
PCA9552_5	20060309	Product data sheet	-	-	PCA9552_4			
Modifications:	information	t of this data sheet has b n standard of Philips Sen	niconductors.		•			
		rdering information": cha PW' to 'PCA9552'	nged Topside mark	of TSSOP24 packa	age from			
		in description": added Ta			N24 package			
		6 "External RESET": cha		"t _{w(rst)} "				
		changed symbol "t _{pv} " to	` '					
		changed symbol "t _{ph} " to	` '	. ,				
		1 "Minimizing I _{DD} when the						
	-	agraph, 3rd sentence: ch						
	-	ragraph, 4th sentence: cl Limiting values":	nanged symbol V _{IN}	i to vi				
	– change	ed parameter description utput pin"	of $V_{\text{I/O}}$ from "DC vo	Itage on an I/O" to	"voltage on an			
	 changed symbol "I_{I/O} (DC output current on an I/O)" to 'I_{O(LEDn)} (output current on pin LEDn) 							
	• Table 13 "	Static characteristics":						
		second sentence of desce at column "Typ"	cription below title to	o (new) <u>Table note 1</u>	and added its			
	– change	ed symbol " ΔI_{DD} " to " ΔI_{Stb} "	,					
		subsection "I/Os", change	,	"				
		Dynamic characteristics"						
	•	d parameter descriptions						
	"t _{su(D)} ";	subsection "Port timing": changed symbol "t _{PH} " to	"t _{h(D)} "	(,				
	under s change	subsection "Reset": chan ed symbol "t _{RESET} " to "t _{rst} "	ged symbol "t _W " to " ' (also in <u>Table note</u>	t _{w(rst)} "; changed syl 5)	mbol "t _{REC} " to "t _{rec(rst)} ";			
	• Figure 21	"Reset timing" modified t	o harmonize letter s	symbols				
PCA9552_4	20041001	Product data sheet	-	9397 750 13727	PCA9552_3			
PCA9552_3	20030502	Product data	853-2374 29857 of 2003 Apr 24	9397 750 11463	PCA9552_2			
PCA9552_2	20030224	Product data	853-2374 29331 of 2002 Dec 20	9397 750 11156	PCA9552_1			
PCA9552_1	20020927	Product data	853-2374 28878 of 2002 Sep 09	9397 750 10329	-			

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18. Data sheet status

Level	Data sheet status [1]	Product status [2] [3]	Definition
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
III	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

- [1] Please consult the most recently issued data sheet before initiating or completing a design.
- [2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.
- [3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

19. Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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16-bit I²C-bus LED driver with programmable blink rates



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